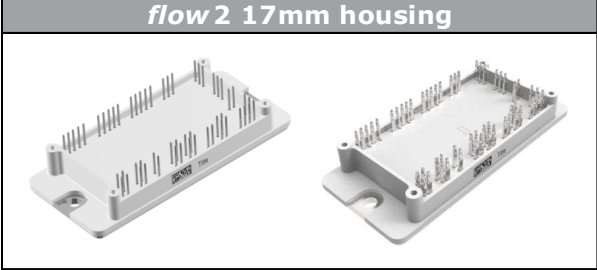
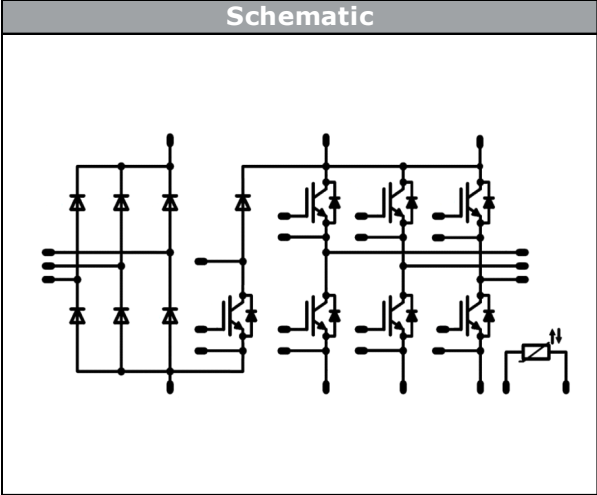




<i>flow</i> PIM 2	1200 V / 100 A
<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Features</p> <ul style="list-style-type: none"> 3~rectifier, BRC, Inverter, NTC Very compact housing, easy to route Mitsubishi IGBT and FWD </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Target applications</p> <ul style="list-style-type: none"> Motor Drives Power Generation </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Types</p> <ul style="list-style-type: none"> V23990-P760-A60-PM V23990-P760-A60Y-PM </div>	<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;"><i>flow</i> 2 17mm housing</p>  </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #ccc; margin: 0;">Schematic</p>  </div>

Maximum Ratings

T_j = 25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	111	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	258	W
Gate-emitter voltage	V_{GES}		±20	V
Maximum Junction Temperature	T_{jmax}		175	°C



Parameter	Symbol	Conditions	Value	Unit
Inverter Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	82	A
Repetitive peak forward current	I_{FRM}		200	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	164	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Parameter	Symbol	Condition	Value	Unit
Brake Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	61	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	100	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	144	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Parameter	Symbol	Conditions	Value	Unit
Brake Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	27	A
Surge (non-repetitive) forward current	I_{FSM}	50Hz Single Half Sine Wave	100	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	69	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$

Parameter	Symbol	Conditions	Value	Unit
Brake Inverse Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	20	A
Repetitive peak forward current	I_{FRM}		20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	29	W
Maximum Junction Temperature	T_{jmax}		175	$^\circ\text{C}$



Parameter	Symbol	Conditions	Value	Unit
Rectifier Diode				
Peak Repetitive Reverse Voltage	V_{RRM}		1600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	74	A
Surge (non-repetitive) forward current	I_{FSM}	50 Hz Single Half Sine Wave $t_p = 10 \text{ ms}$ 50 Hz sine $T_j = 150^\circ\text{C}$	890	A
Surge current capability	I^2t		3960	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_h = 80^\circ\text{C}$	141	W
Maximum Junction Temperature	T_{jmax}		150	°C

Parameter	Symbol	Conditions	Value	Unit
Module Properties				
Thermal Properties				
Storage temperature	T_{stg}		-40...+125	°C
Operation Junction Temperature	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties					
Isolation voltage	V_{isol}	DC voltage	$t_p=2s$	4000	V
Creepage distance				min 12,7	mm
Clearance		with Press-fit pins / with Solder pins		11,96 / 12,03	mm
Comparative Tracking Index	CTI			>200	



Characteristic Values

Inverter Switch

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max		

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}$			0,01	25 125	5,4	6	6,6	V
Collector-emitter saturation voltage	V_{CEsat}		15		100	25 125 150	1,2	1,77 2,05 2,11	2,2	V
Collector-emitter cut-off current	I_{CES}		0	1200		25 125			300	µA
Gate-emitter leakage current	I_{GES}		20	0		25 125			1000	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	f=100 KHz	0	10		25		6200		pF
Output capacitance	C_{oes}							680		
Reverse transfer capacitance	C_{res}							74		
Gate charge	Q_g		15	600	100	25		210		nC

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material λ=3,4W/mK						0,37		K/W
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IGBT Switching

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	±15	600	100	25 125 150		63 63 64		ns
Rise time	t_r					25 125 150		7 9 9		
Turn-off delay time	$t_{d(off)}$					25 125 150		146 190 202		
Fall time	t_f					25 125 150		55 76 81		
Turn-on energy (per pulse)	E_{on}	$Q_{rFWD} = 8,2 \mu C$ $Q_{rFWD} = 19,5 \mu C$ $Q_{rFWD} = 22,2 \mu C$				25 125 150		2,002 3,517 4,014		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		4,777 7,481 8,253		



Inverter Diode

Parameter	Symbol	Conditions					Value			Unit
				V_r [V]	I_F [A]	T_j [°C]	Min	Typ	Max	
Static										
Forward voltage	V_F				100	25 125 150		2,57 2,31 2,19	3,3	V
Reverse leakage current	I_r			1200		25 150			50 -	μ A
Thermal										
Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material $\lambda=3,4W/mK$						0,58		K/W
FWD Switching										
Peak recovery current	I_{RRM}	$di/dt = 13103 A/\mu s$ $di/dt = 10356 A/\mu s$ $di/dt = 9265 A/\mu s$	± 15	600	100	25 125 150		160 184 191		A
Reverse recovery time	t_{rr}					25 125 150		98 136 143		ns
Recovered charge	Q_r					25 125 150		8,215 19,527 22,208		μ C
Reverse recovered energy	E_{rec}					25 125 150		3,929 9,926 11,221		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		13494 5569 4331		A/ μ s



Brake Switch

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max		

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}$			0,005	25 125	5,4	6	6,6	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	25 125 150	1,2	1,73 2,00 2,06	2,2	V
Collector-emitter cut-off current	I_{CES}		0	1200		25 125			150	µA
Gate-emitter leakage current	I_{GES}		20	0		25 125			500	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	f=100 KHz	0	10		25		3100		pF
Output capacitance	C_{oes}							340		
Reverse transfer capacitance	C_{res}							37		
Gate charge	Q_g		15	600	50	25		105		nC

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material $\lambda=3,4W/mK$						0,66		K/W
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IGBT Switching

Turn-on delay time	$t_{d(on)}$	$R_{goff} = 8 \Omega$ $R_{gon} = 8 \Omega$	± 15	600	50	25		51		ns
Rise time	t_r					125		51		
Turn-off delay time	$t_{d(off)}$					150		51		
Fall time	t_f					25		9		
Turn-on energy (per pulse)	E_{on}					125		11		
Turn-off energy (per pulse)	E_{off}	150		12						
		25		134						
		125		174						
Turn-on energy (per pulse)	E_{on}	150		186						
		25		53						
		125		76						
Turn-off energy (per pulse)	E_{off}	150		83						
		25		1,665						
		125		2,281						
Turn-off energy (per pulse)	E_{off}	150		2,541						
		25		2,538						
		125		3,868						
						150		4,259		



Brake Diode

Parameter	Symbol	Conditions					Value			Unit
				V_r [V]	I_F [A]	T_j [°C]	Min	Typ	Max	
Static										
Forward voltage	V_F				25	25 125 150		2,47 - 2,49	2,74	V
Reverse leakage current	I_r			1200		25 150			60 -	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material $\lambda=3,4W/mK$						1,38		K/W
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FWD Switching

Peak recovery current	I_{RRM}	$di/dt = 3330 A/\mu s$ $di/dt = 3225 A/\mu s$ $di/dt = 4192 A/\mu s$	± 15	600	50	25		56		A
						125		56		
						150		59		
Reverse recovery time	t_{rr}					25		104		ns
						125		124		
		150		129						
Recovered charge	Q_r					25		3,139		µC
						125		5,458		
						150		6,049		
Reverse recovered energy	E_{rec}					25		1,313		mWs
						125		2,453		
						150		2,678		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25		2327		A/µs
						125		1949		
						150		1339		

Brake Inverse Diode

Parameter	Symbol	Conditions					Value			Unit
				V_r [V]	I_F [A]	T_j [°C]	Min	Typ	Max	
Static										
Forward voltage	V_F				10	25 125 150		1,76 - 1,68	2,05	V
Reverse leakage current	I_r			1200		25 150			2,7 -	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material $\lambda=3,4W/mK$						1,62		K/W
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Rectifier Diode

Parameter	Symbol	Conditions					Value			Unit
				V_r [V]	I_F [A]	T_j [°C]	Min	Typ	Max	

Static

Forward voltage	V_F				60	25 125 150		1,64 - 1,70	1,5	V
Reverse leakage current	I_r			1600		25 150			100 2000	μ A

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	Phase-Change Material $\lambda=3,4W/mK$						0,5		K/W
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Thermistor

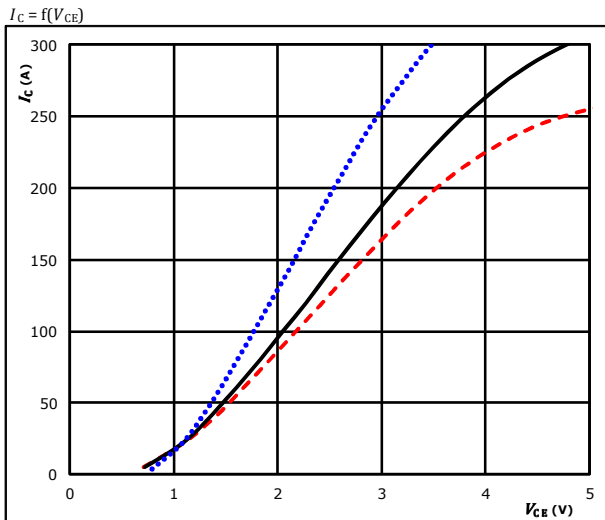
Parameter	Symbol	Conditions					Value			Unit
				V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	

Rated resistance	R					25		21,5		k Ω
Deviation of R100	$\Delta_{R/R}$	R100=1486 Ω				100	-4,5		+4,5	%
Power dissipation	P					25		210		mW
Power dissipation constant						25		3,5		mW/K
B-value	$B_{(25/50)}$					25		3884		K
B-value	$B_{(25/100)}$					25		3964		K
Vincotech NTC Reference									F	



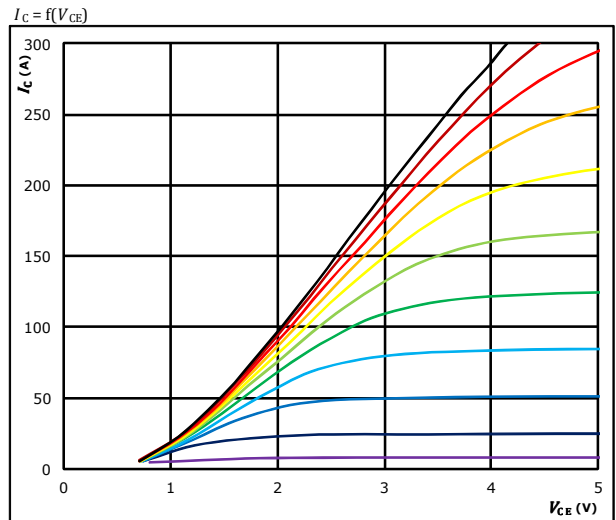
Inverter Switch Characteristics

Typical output characteristics IGBT



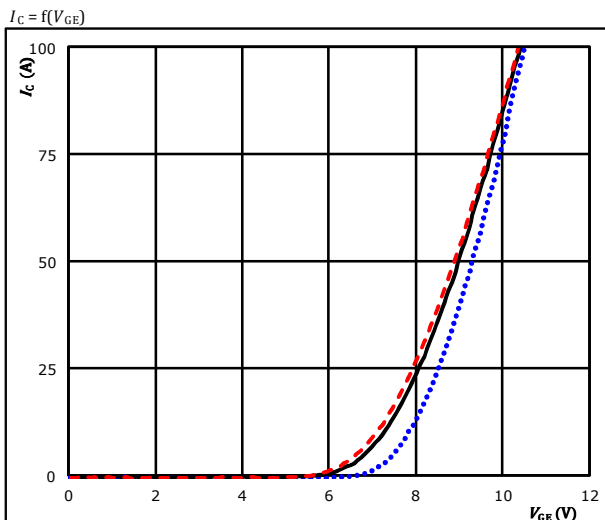
$t_p = 250 \mu\text{s}$
 $V_{GE} = 15 \text{ V}$
25 °C
125 °C ———
150 °C - - - -

Typical output characteristics IGBT



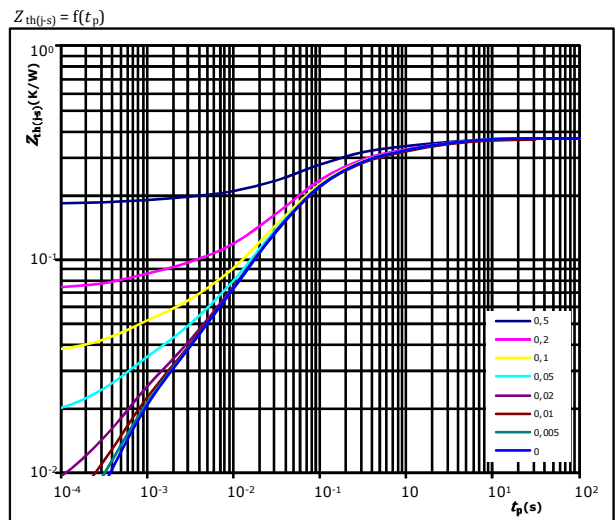
$t_p = 250 \mu\text{s}$
 $T_j = 150 \text{ °C}$
 V_{GE} from 7 V to 17 V in steps of 1 V

Typical transfer characteristics IGBT



$t_p = 100 \mu\text{s}$
 $V_{CE} = 10 \text{ V}$
25 °C
125 °C ———
150 °C - - - -

Transient Thermal Impedance as function of Pulse duration IGBT



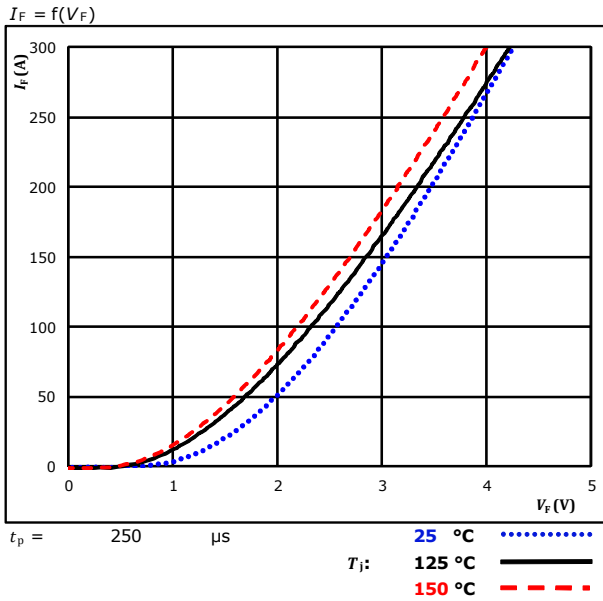
$D = \frac{t_p}{T}$
 $R_{th(j-s)} = 0,37 \text{ K/W}$
IGBT thermal model values

$R_{th} \text{ (K/W)}$	$\tau \text{ (s)}$
3,83E-02	3,87E+00
6,03E-02	6,84E-01
1,21E-01	1,20E-01
1,08E-01	3,47E-02
2,26E-02	6,82E-03
1,80E-02	7,32E-04

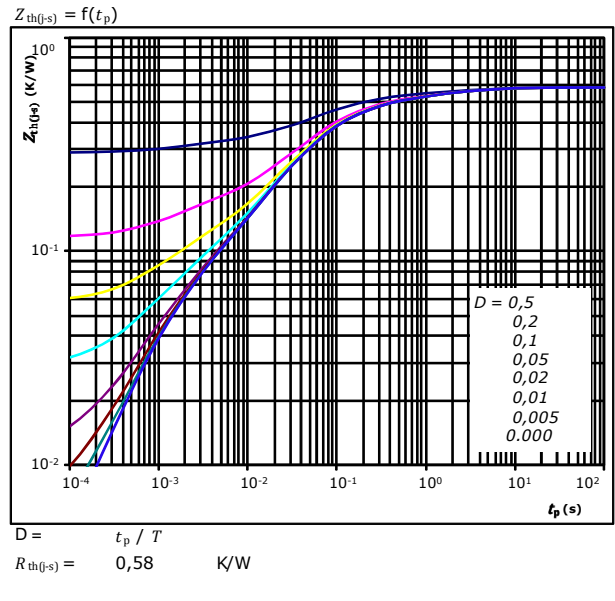


Inverter Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



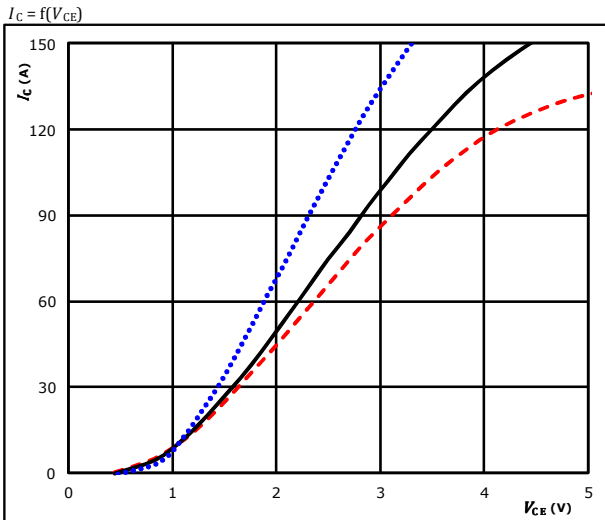
FWD thermal model values

R (K/W)	τ (s)
3,85E-02	4,56E+00
7,24E-02	8,53E-01
1,66E-01	1,38E-01
2,11E-01	3,67E-02
4,46E-02	8,35E-03
4,75E-02	1,22E-03



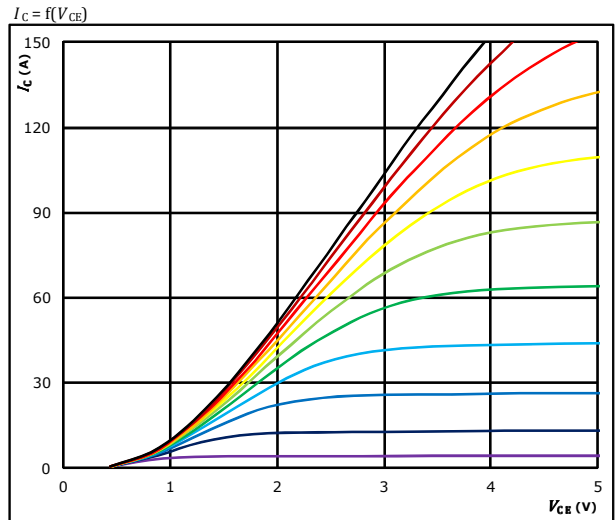
Brake Switch Characteristics

Typical output characteristics IGBT



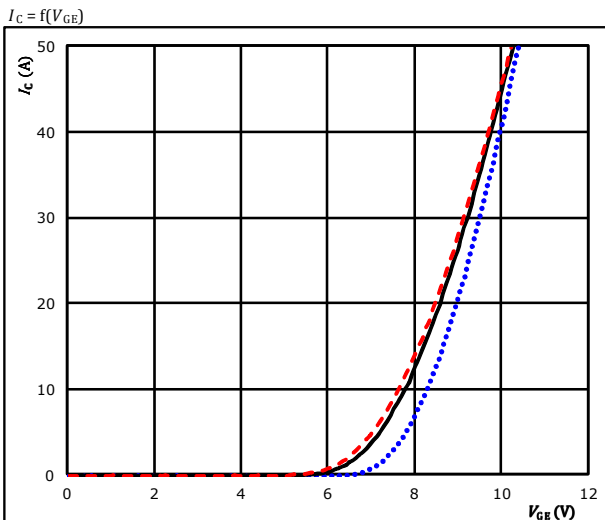
$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 25 °C
 125 °C ———
 150 °C - - - -

Typical output characteristics IGBT



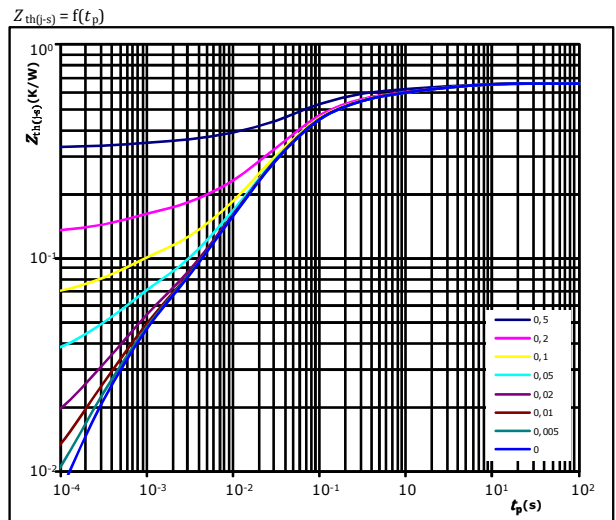
$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{CE} from 7 V to 17 V in steps of 1 V

Typical transfer characteristics IGBT



$t_p = 100 \mu s$
 $V_{CE} = 10 V$
 25 °C
 125 °C ———
 150 °C - - - -

Transient Thermal Impedance as function of Pulse duration IGBT



$D = t_p / T$
 $R_{th(j-s)} = 0,66 \text{ K/W}$

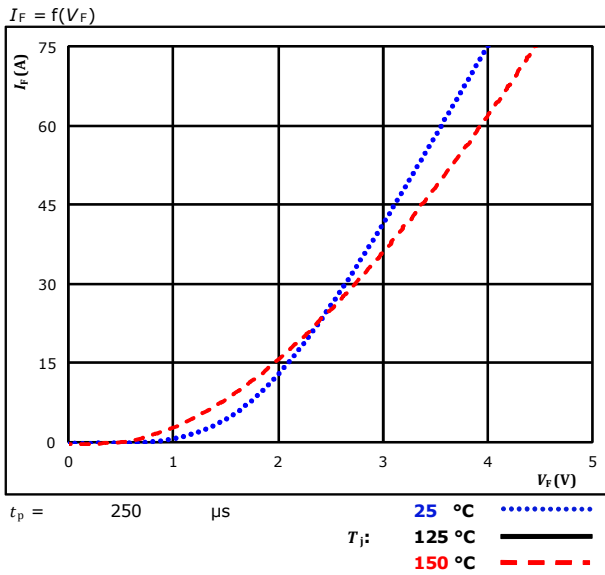
IGBT thermal model values

R_{th} (K/W)	τ (s)
5,47E-02	4,08E+00
7,84E-02	6,81E-01
1,96E-01	1,11E-01
2,54E-01	3,17E-02
4,44E-02	4,90E-03
3,28E-02	4,86E-04

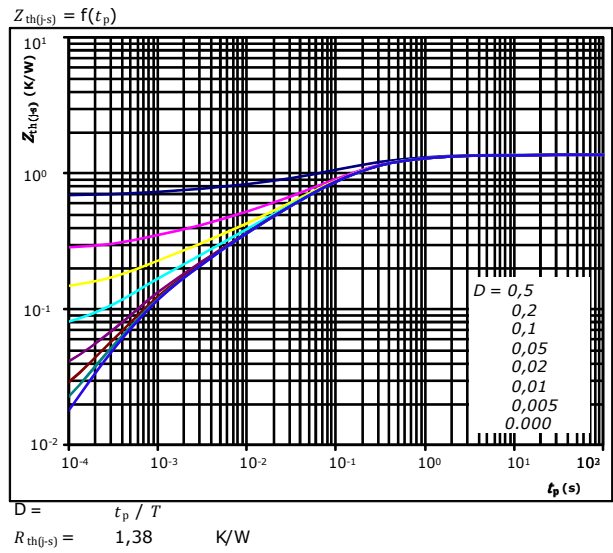


Brake Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



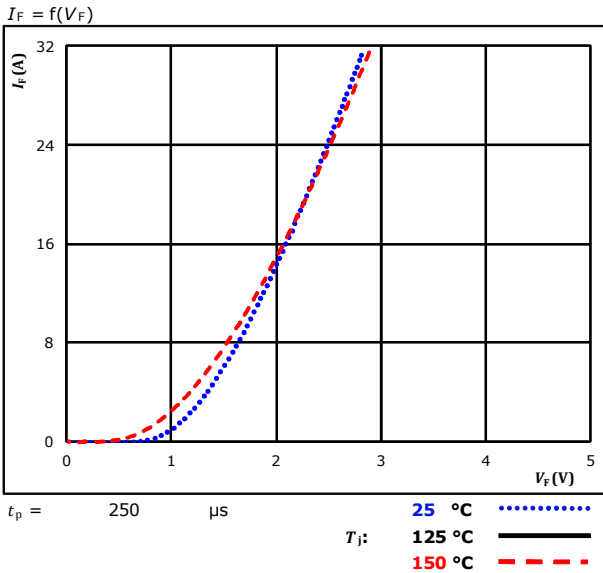
FWD thermal model values

R (K/W)	τ (s)
2,65E-02	9,28E+00
2,03E-01	7,62E-01
5,75E-01	1,47E-01
3,32E-01	2,99E-02
1,56E-01	4,40E-03
8,92E-02	6,49E-04

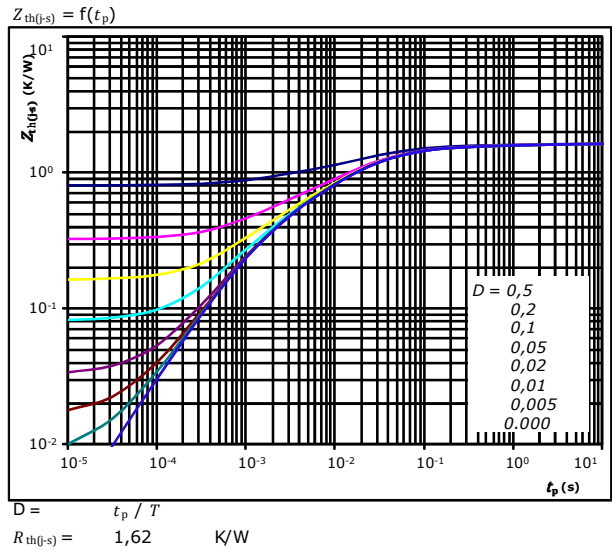


Brake Inverse Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



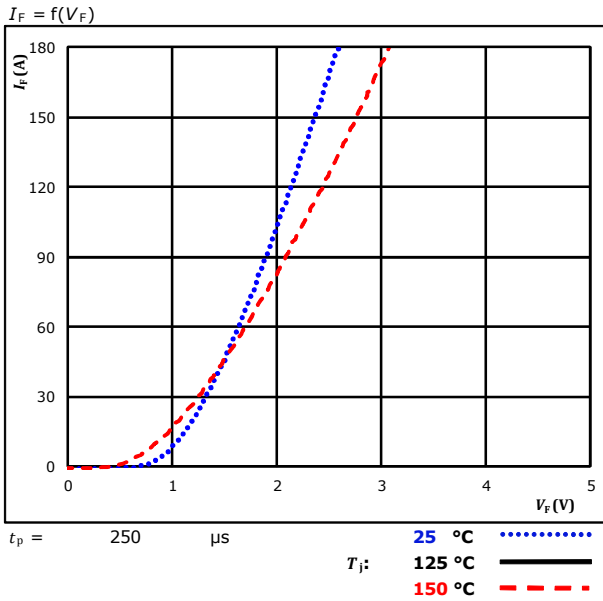
FWD thermal model values

R (K/W)	τ (s)
6,84E-02	2,41E+00
1,62E-01	1,88E-01
6,14E-01	3,05E-02
5,11E-01	7,89E-03
2,69E-01	1,18E-03

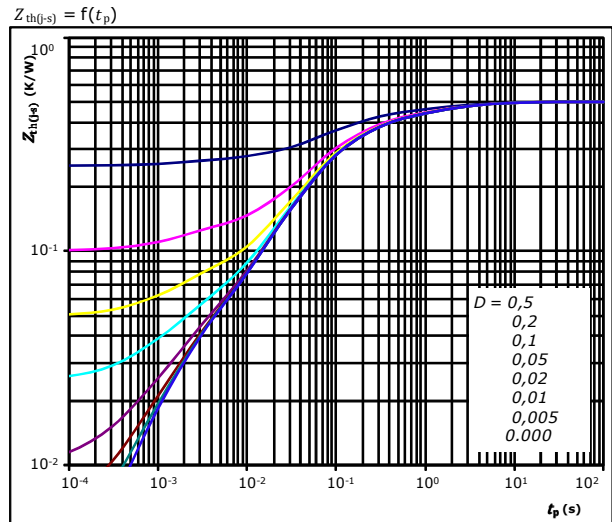


Rectifier Diode Characteristics

Typical forward characteristics Rectifier Diode



Transient thermal impedance as a function of pulse width Rectifier Diode



$D = t_p / T$
 $R_{th(j-s)} = 0,5 \text{ K/W}$

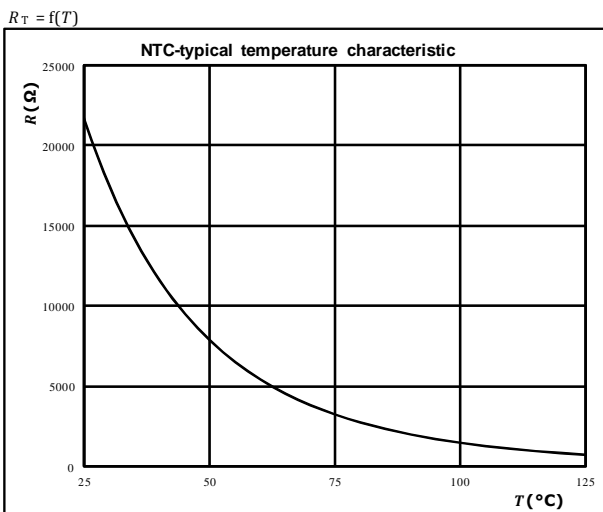
Diode thermal model values

R (K/W)	τ (s)
4,13E-02	4,29E+00
9,77E-02	7,26E-01
1,88E-01	1,21E-01
1,43E-01	3,68E-02
2,79E-02	1,66E-03

Thermistor

Thermistor typical temperature characteristic

Typical NTC characteristic
 as a function of temperature

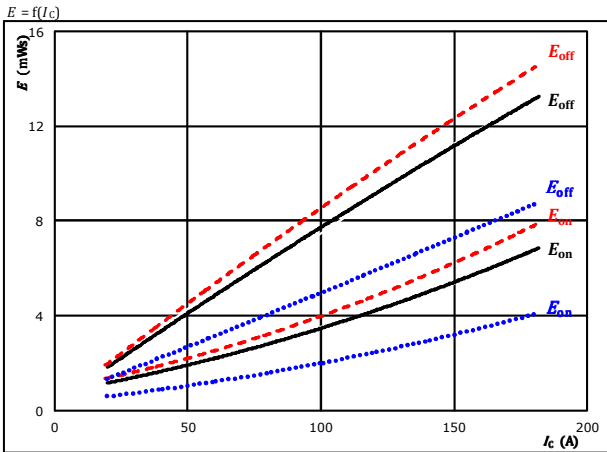




Inverter Switching Characteristics

Figure 1. IGBT

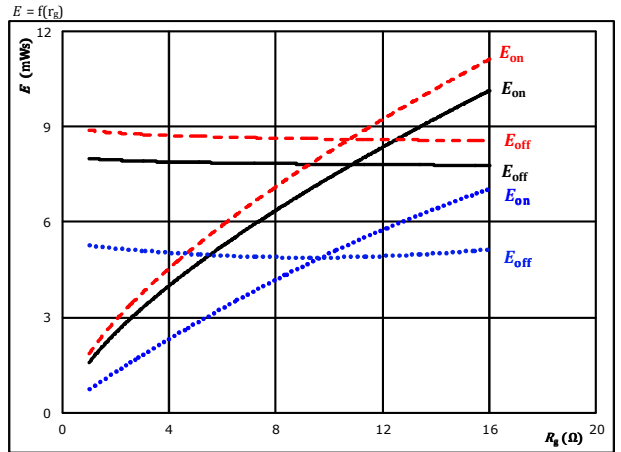
Typical switching energy losses as a function of collector current



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{g\text{on}} = 4$ Ω
 $R_{g\text{off}} = 4$ Ω
 T_j : 25 °C
 125 °C ———
 150 °C - - - -

Figure 2. IGBT

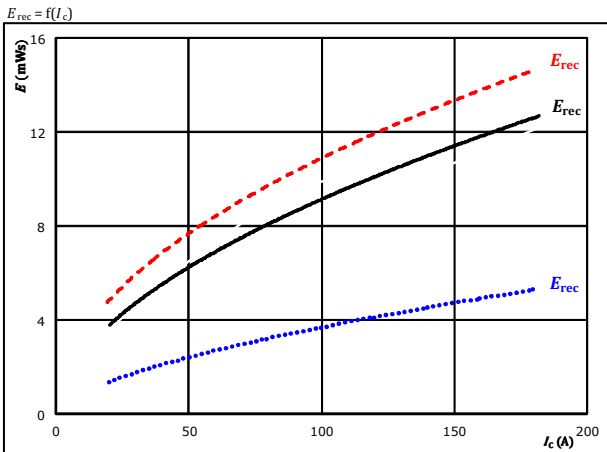
Typical switching energy losses as a function of gate resistor



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 100$ A
 T_j : 25 °C
 125 °C ———
 150 °C - - - -

Figure 3. FWD

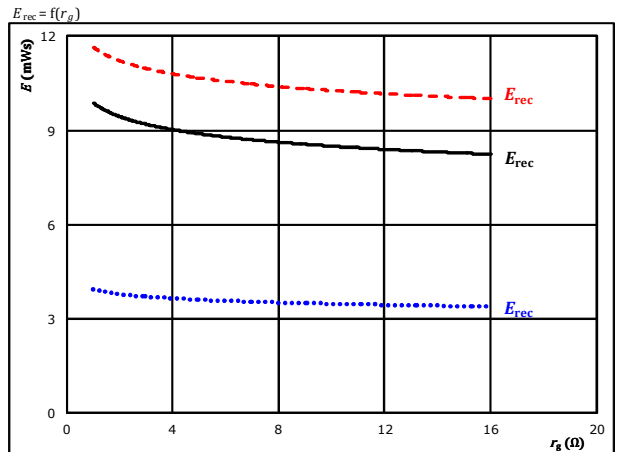
Typical reverse recovered energy loss as a function of collector current



With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{g\text{on}} = 4$ Ω
 T_j : 25 °C
 125 °C ———
 150 °C - - - -

Figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor



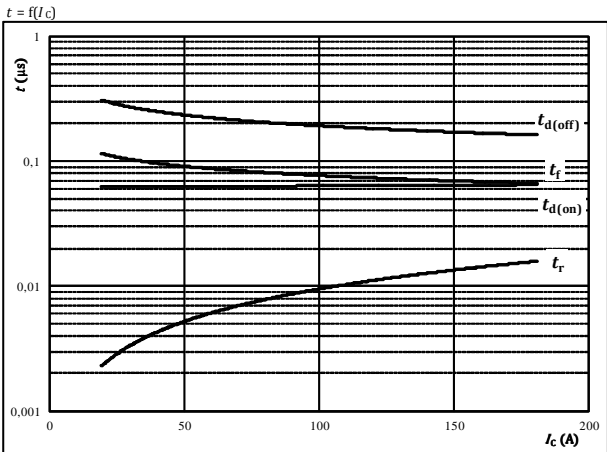
With an inductive load at
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 100$ A
 T_j : 25 °C
 125 °C ———
 150 °C - - - -



Inverter Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

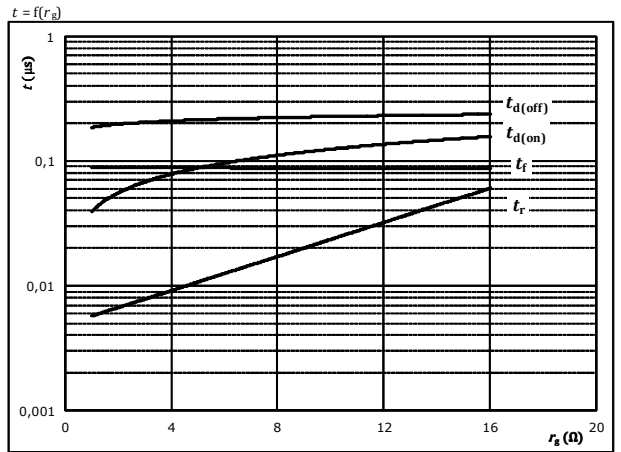


With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{g(on)} =$	4	Ω
$R_{g(off)} =$	4	Ω

Figure 6. IGBT

Typical switching times as a function of gate resistor

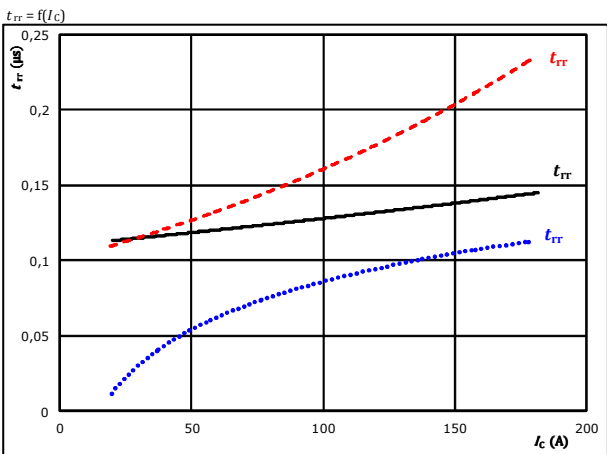


With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	100	A

Figure 7. FWD

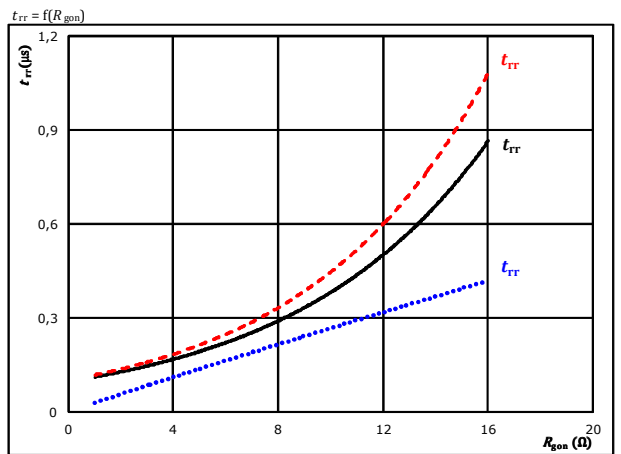
Typical reverse recovery time as a function of collector current



At	$V_{CE} =$	600	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		125 °C	————
	$R_{g(on)} =$	4	Ω		150 °C	-----

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor



At	$V_{CE} =$	600	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		125 °C	————
	$I_C =$	100	A		150 °C	-----



Inverter Switching Characteristics

Figure 9. FWD
Typical recovered charge as a function of collector current

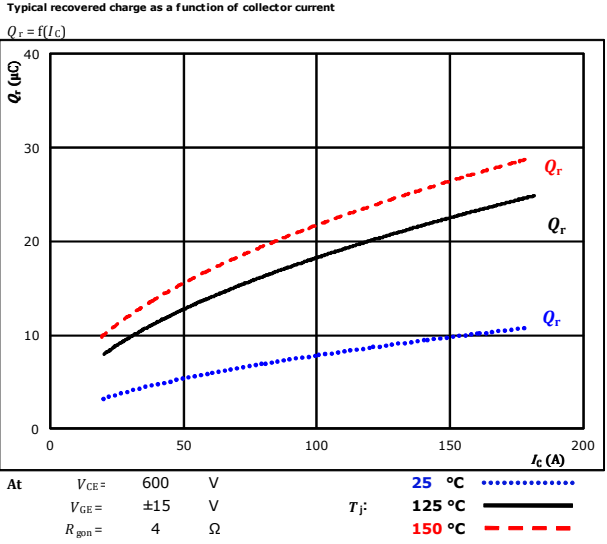


Figure 10. FWD
Typical recovered charge as a function of IGBT turn on gate resistor

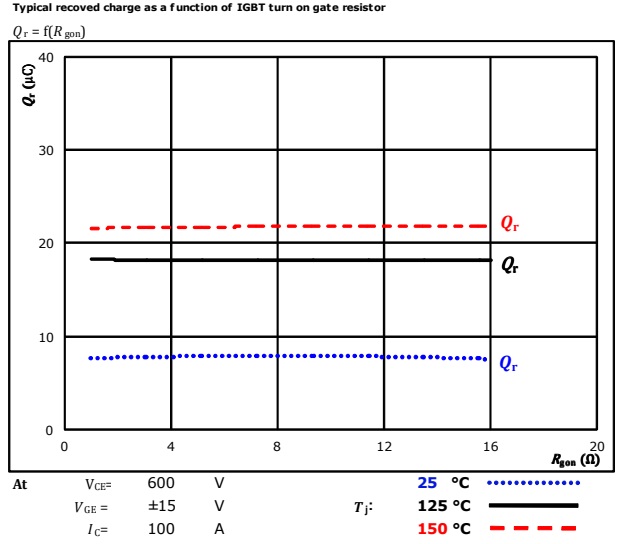


Figure 11. FWD
Typical peak reverse recovery current current as a function of collector current

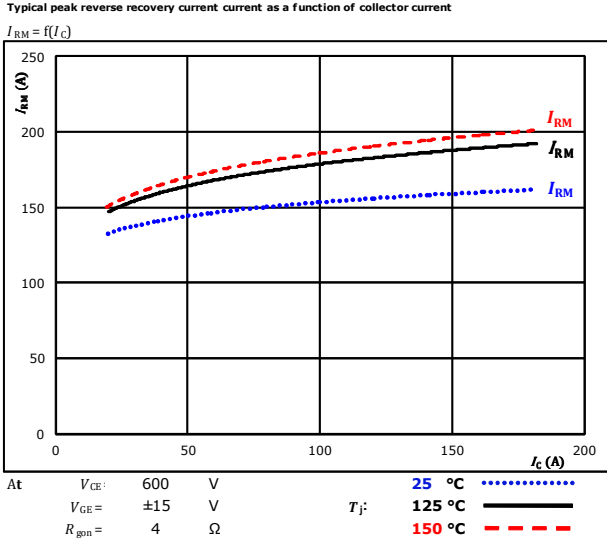
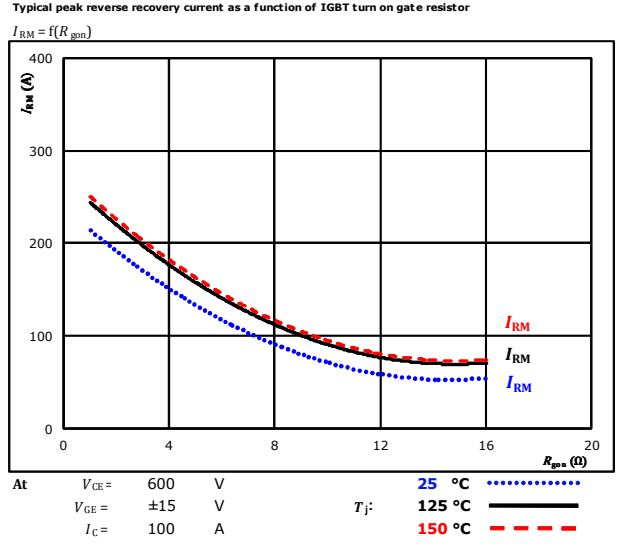


Figure 12. FWD
Typical peak reverse recovery current as a function of IGBT turn on gate resistor

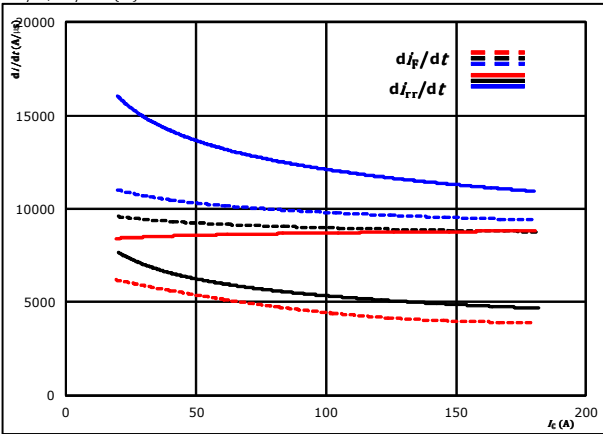




Inverter Switching Characteristics

Figure 13. FWD

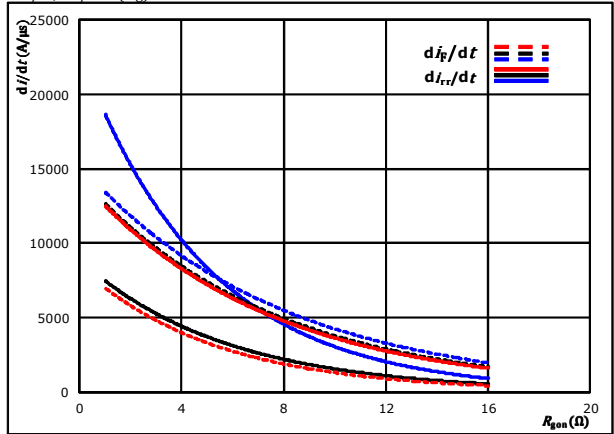
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_F/dt, di_{rr}/dt = f(I_C)$



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C
 125 °C
 150 °C

Figure 14. FWD

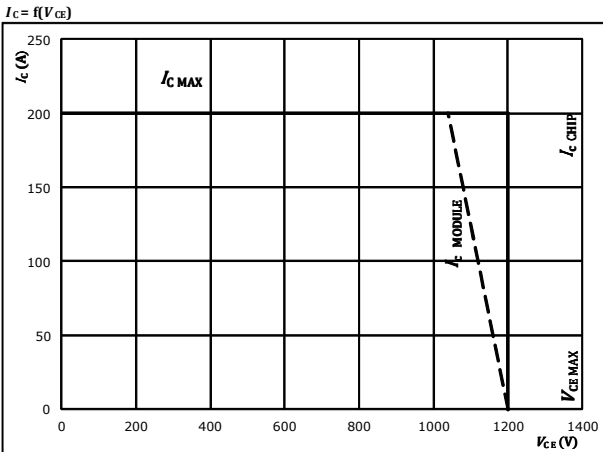
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_F/dt, di_{rr}/dt = f(R_g)$



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 100$ A

Figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



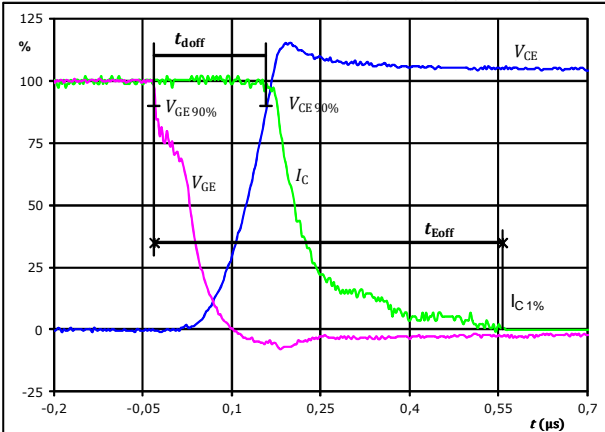
Inverter Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

Figure 1. IGBT

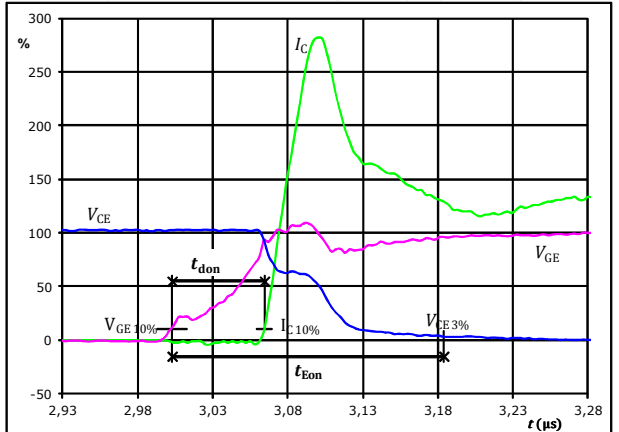
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_{doff} =$	0,19	μs
$t_{Eoff} =$	0,588	μs

Figure 2. IGBT

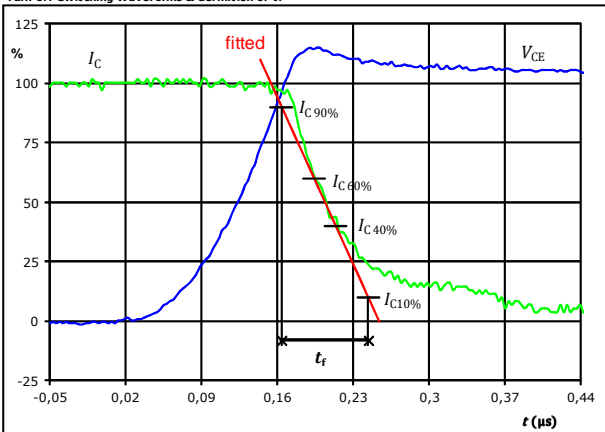
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_{don} =$	0,063	μs
$t_{Eon} =$	0,18	μs

Figure 3. IGBT

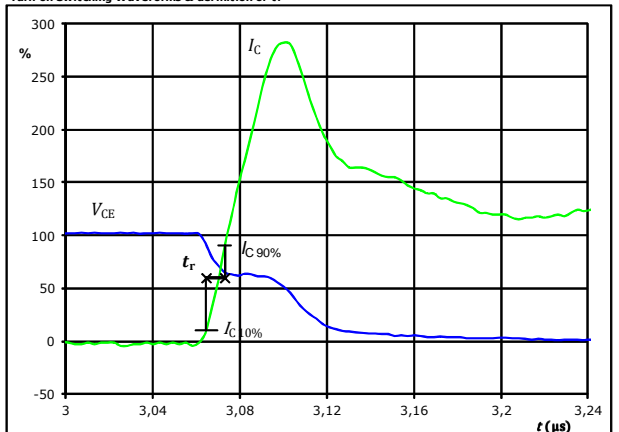
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_f =$	0,076	μs

Figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r

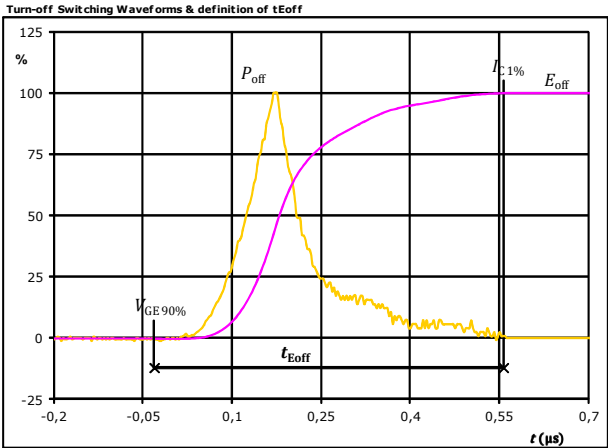


$V_C(100\%) =$	600	V
$I_C(100\%) =$	100	A
$t_r =$	0,009	μs



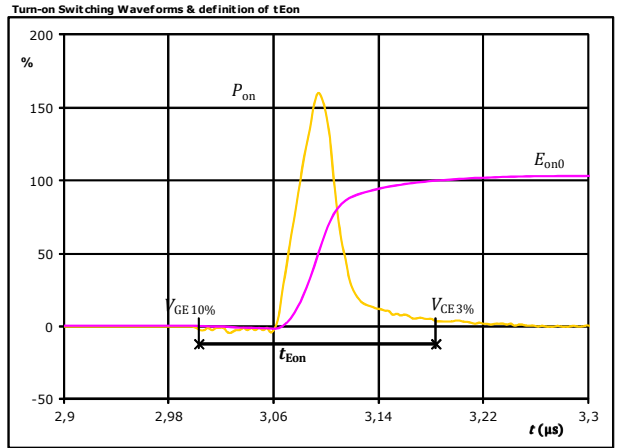
Inverter Switching Definitions

Figure 5. IGBT



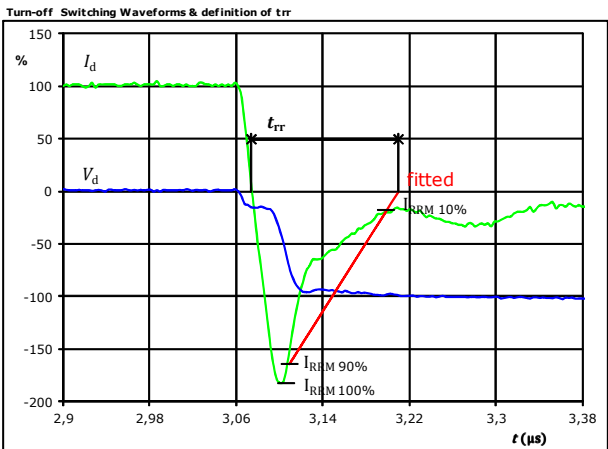
$P_{off}(100\%) =$	59,93	kW
$E_{off}(100\%) =$	7,48	mJ
$t_{Eoff} =$	0,588	μ s

Figure 6. IGBT



$P_{on}(100\%) =$	59,93	kW
$E_{on}(100\%) =$	3,52	mJ
$t_{Eon} =$	0,181	μ s

Figure 7. FWD

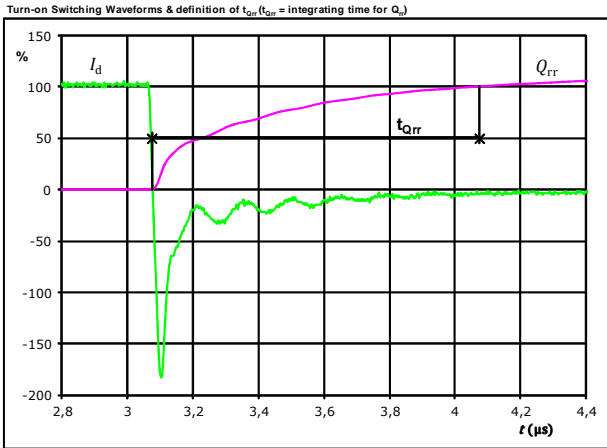


$V_d(100\%) =$	600	V
$I_d(100\%) =$	100	A
$I_{RRM}(100\%) =$	-184	A
$t_{rr} =$	0,136	μ s



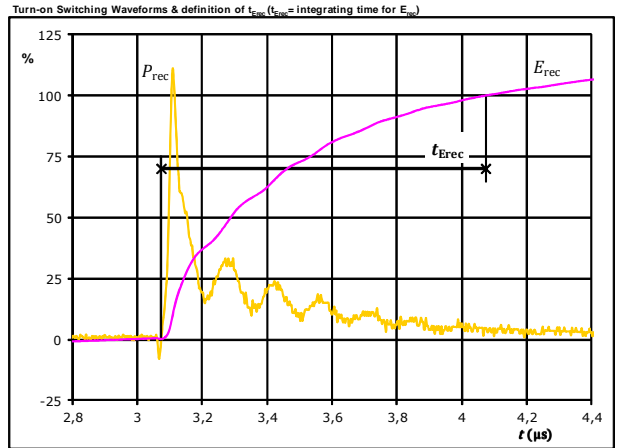
Inverter Switching Definitions

Figure 8. FWD



$I_d(100\%) = 100$ A
 $Q_{rr}(100\%) = 19,53$ μC
 $t_{Qrr} = 1,00$ μs

Figure 9. FWD

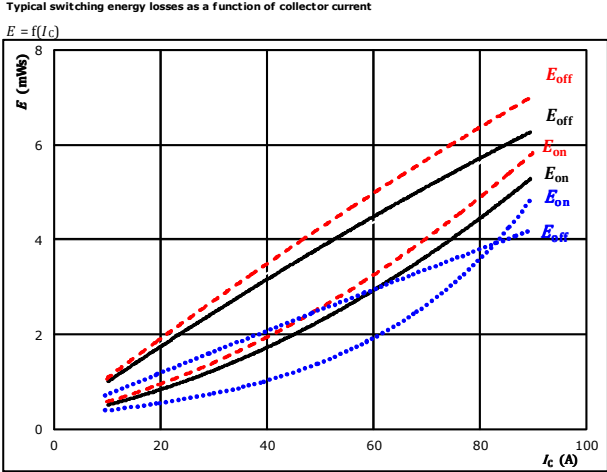


$P_{rec}(100\%) = 59,93$ kW
 $E_{rec}(100\%) = 9,93$ mJ
 $t_{Erec} = 1,00$ μs



Brake Switching Characteristics

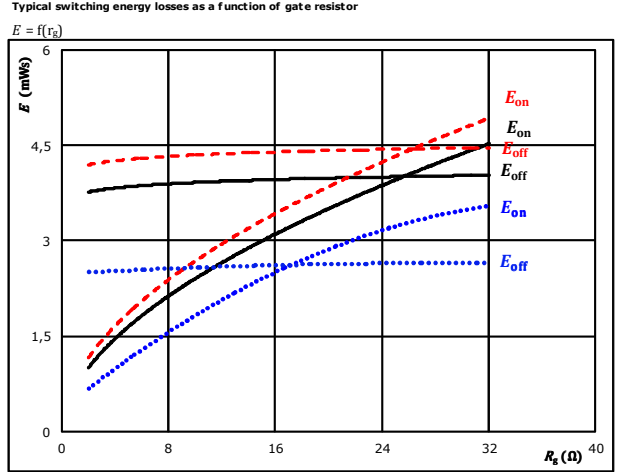
Figure 1. IGBT
Typical switching energy losses as a function of collector current



With an inductive load at

$V_{CE} = 600$ V	$T_j:$ 25 °C
$V_{GE} = \pm 15$ V	125 °C	————
$R_{g\text{on}} = 8$ Ω	150 °C	-----
$R_{g\text{off}} = 8$ Ω		

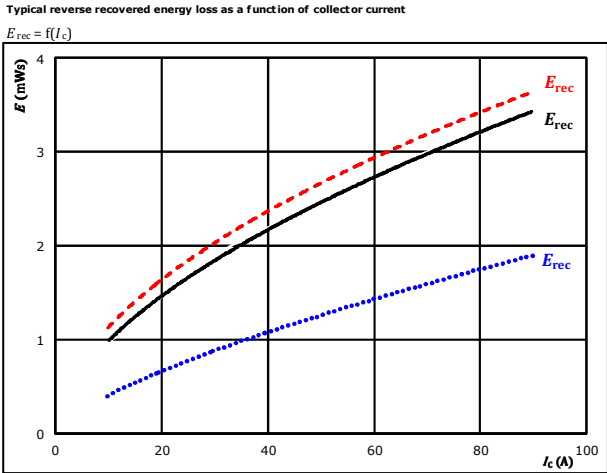
Figure 2. IGBT
Typical switching energy losses as a function of gate resistor



With an inductive load at

$V_{CE} = 600$ V	$T_j:$ 25 °C
$V_{GE} = \pm 15$ V	125 °C	————
$I_C = 50$ A	150 °C	-----

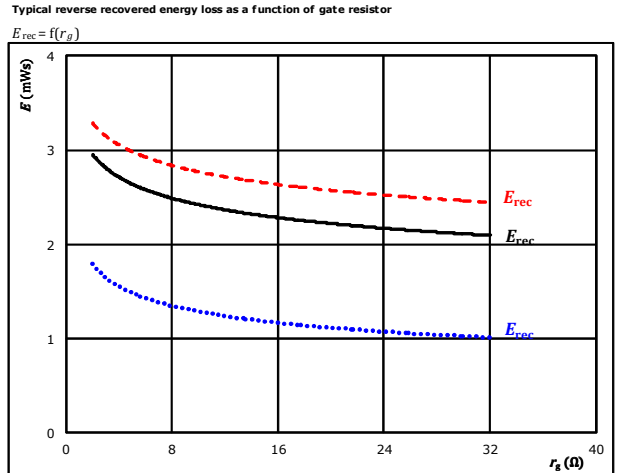
Figure 3. FWD
Typical reverse recovered energy loss as a function of collector current



With an inductive load at

$V_{CE} = 600$ V	$T_j:$ 25 °C
$V_{GE} = \pm 15$ V	125 °C	————
$R_{g\text{on}} = 8$ Ω	150 °C	-----

Figure 4. FWD
Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at

$V_{CE} = 600$ V	$T_j:$ 25 °C
$V_{GE} = \pm 15$ V	125 °C	————
$I_C = 50$ A	150 °C	-----

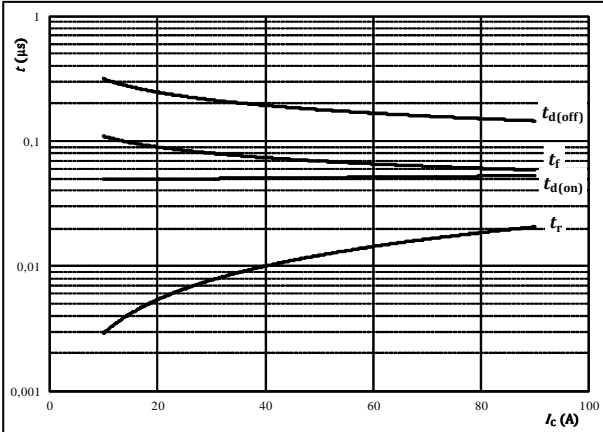


Brake Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



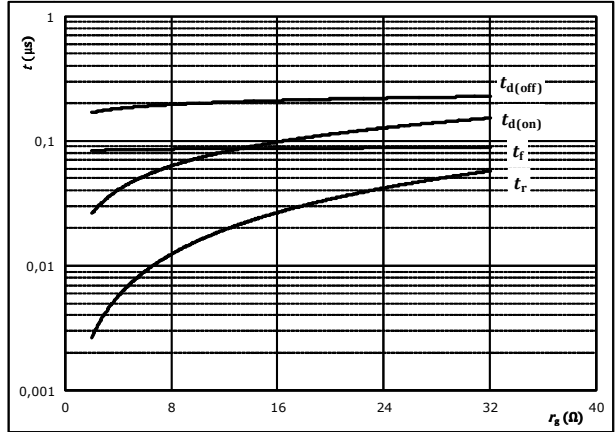
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{g(on)} =$	8	Ω
$R_{g(off)} =$	8	Ω

Figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(r_g)$$



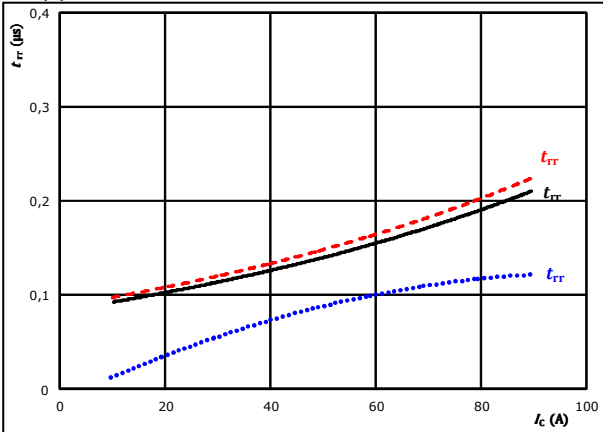
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	50	A

Figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

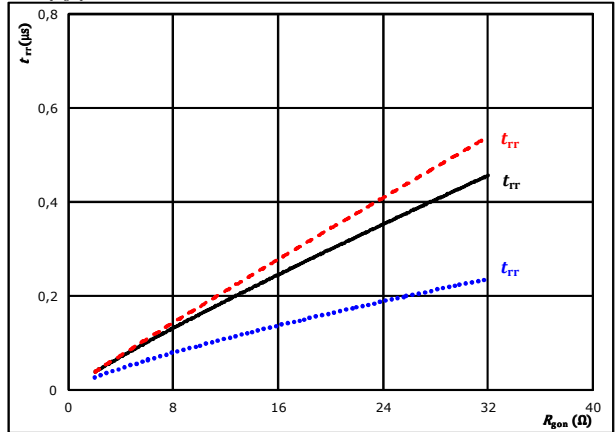


At	$V_{CE} =$	600	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		125 °C	————
	$R_{g(on)} =$	8	Ω		150 °C	-----

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{g(on)})$$



At	$V_{CE} =$	600	V	$T_j:$	25 °C
	$V_{GE} =$	±15	V		125 °C	————
	$I_C =$	50	A		150 °C	-----



Brake Switching Characteristics

Figure 9. FWD
Typical recovered charge as a function of collector current

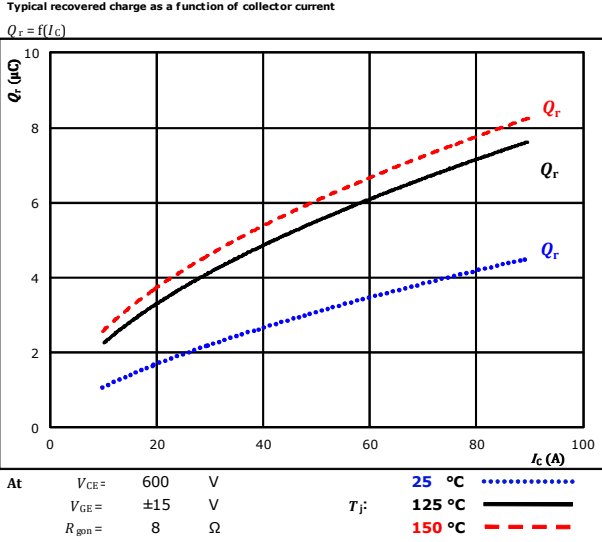


Figure 10. FWD
Typical recovered charge as a function of IGBT turn on gate resistor

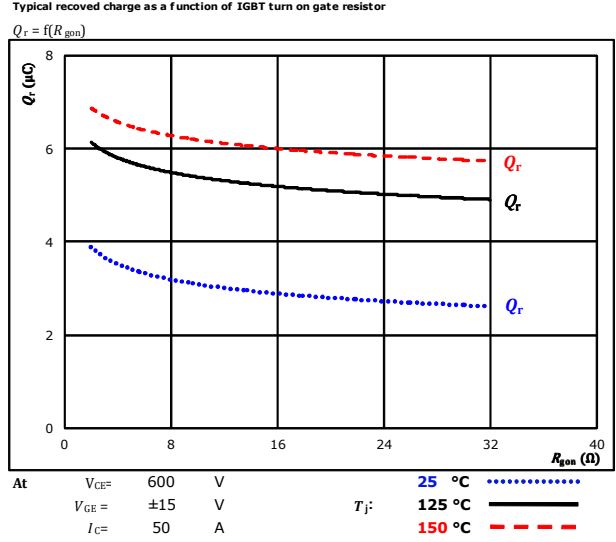


Figure 11. FWD
Typical peak reverse recovery current as a function of collector current

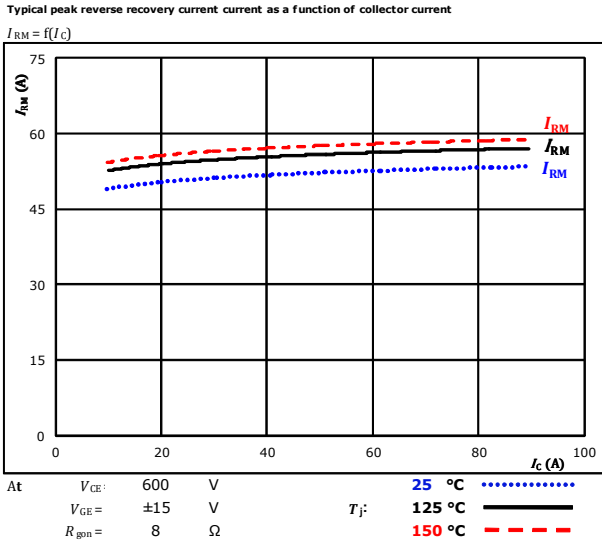
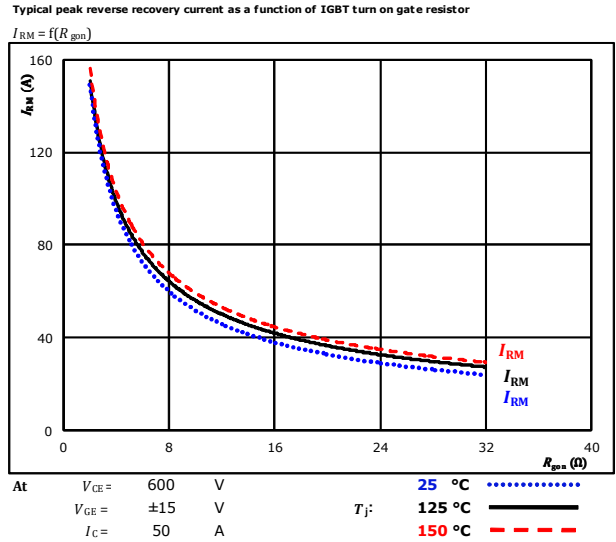


Figure 12. FWD
Typical peak reverse recovery current as a function of IGBT turn on gate resistor

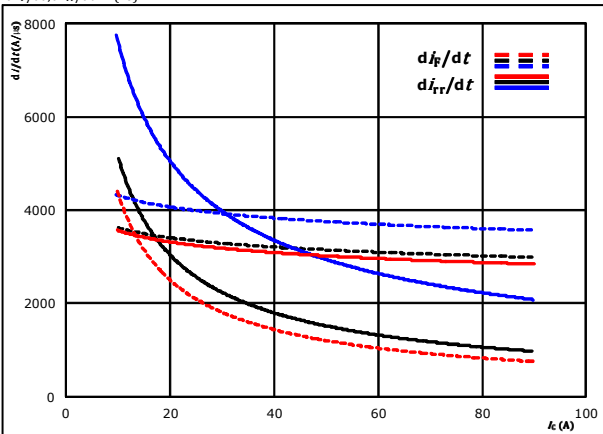




Brake Switching Characteristics

Figure 13. FWD

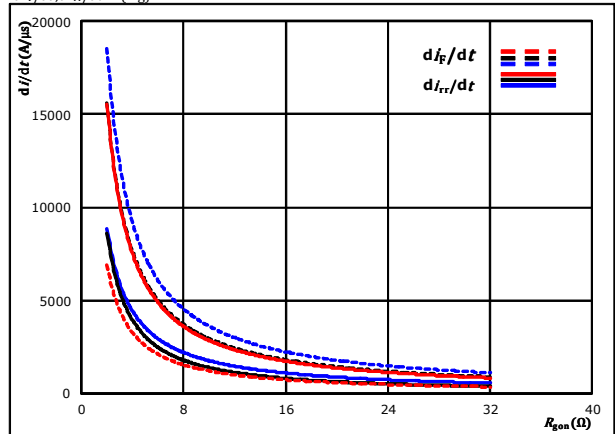
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_F/dt, di_{rr}/dt = f(I_c)$



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $T_j = 25$ °C
 125 °C
 150 °C

Figure 14. FWD

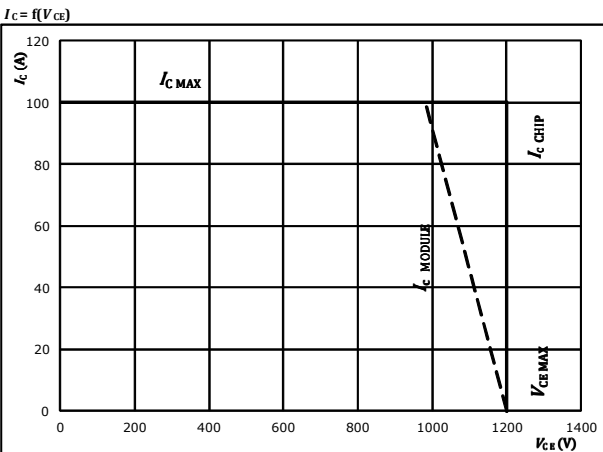
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_F/dt, di_{rr}/dt = f(R_g)$



At $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A

Figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω



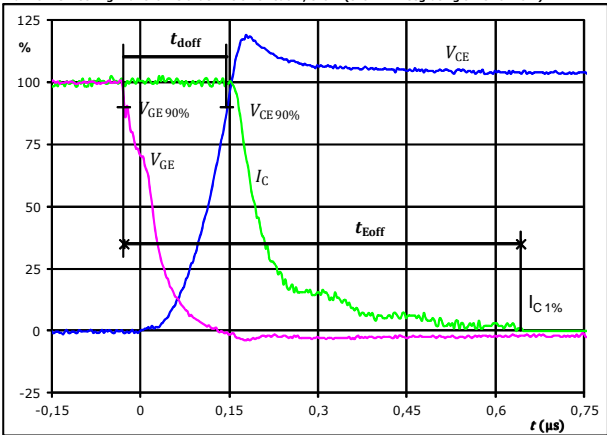
Brake Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

Figure 1. IGBT

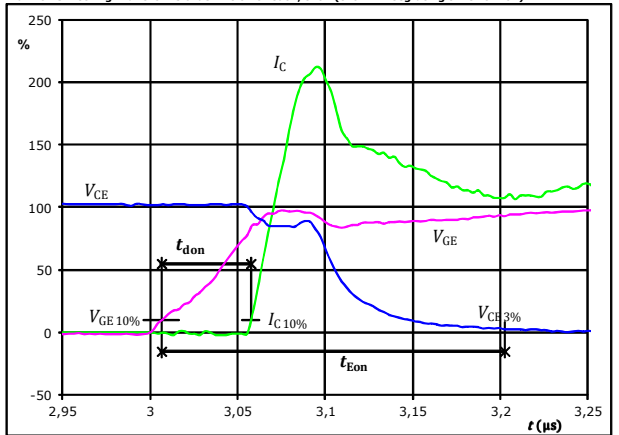
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_{doff} =$	0,174	μs
$t_{Eoff} =$	0,67	μs

Figure 2. IGBT

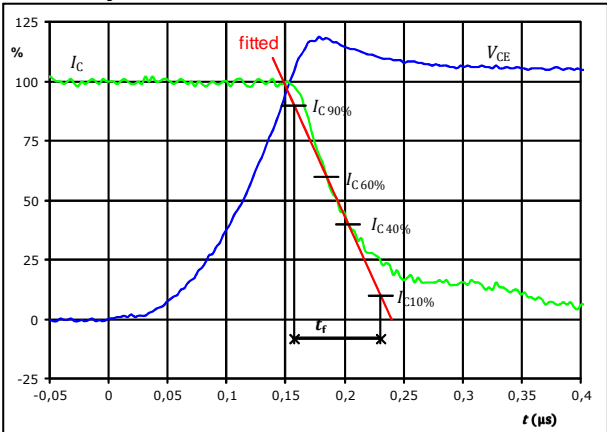
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_{don} =$	0,051	μs
$t_{Eon} =$	0,196	μs

Figure 3. IGBT

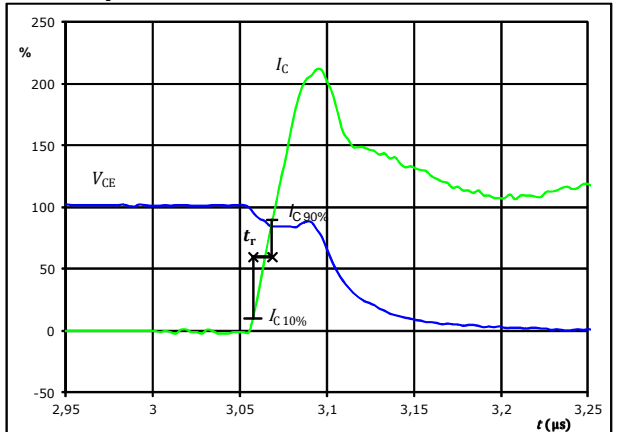
Turn-off Switching Waveforms & definition of t_f



$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_f =$	0,076	μs

Figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r

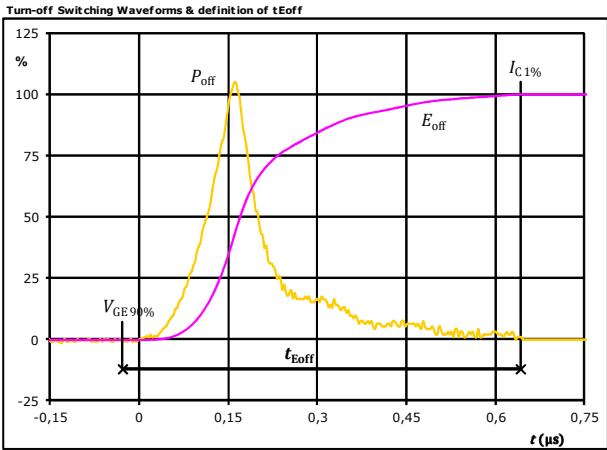


$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_r =$	0,011	μs



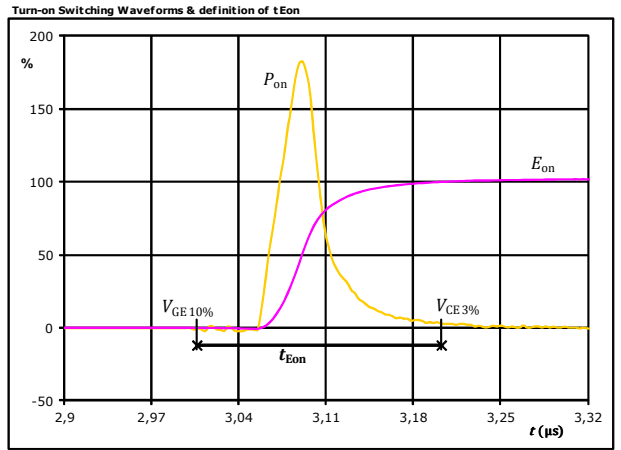
Brake Switching Definitions

Figure 5. IGBT



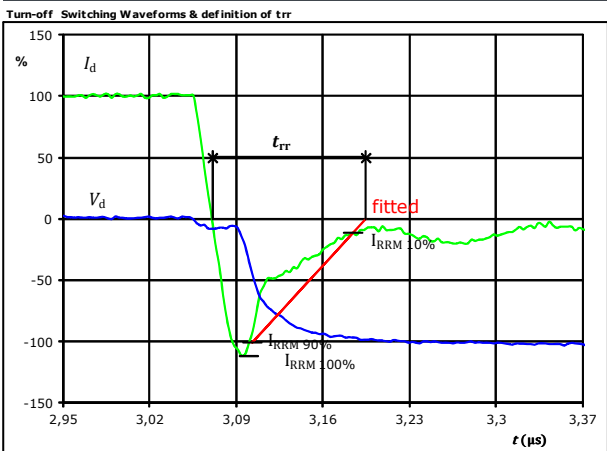
$P_{off}(100\%) =$	29,99	kW
$E_{off}(100\%) =$	3,87	mJ
$t_{Eoff} =$	0,67	μ s

Figure 6. IGBT



$P_{on}(100\%) =$	29,99	kW
$E_{on}(100\%) =$	2,28	mJ
$t_{Eon} =$	0,196	μ s

Figure 7. FWD

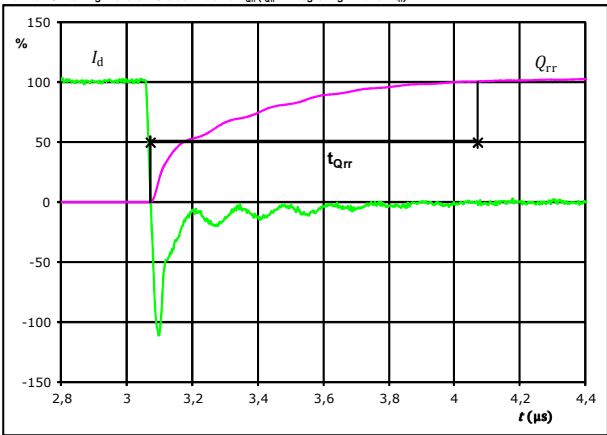


$V_d(100\%) =$	600	V
$I_d(100\%) =$	50	A
$I_{RRM}(100\%) =$	-56	A
$t_{rr} =$	0,124	μ s



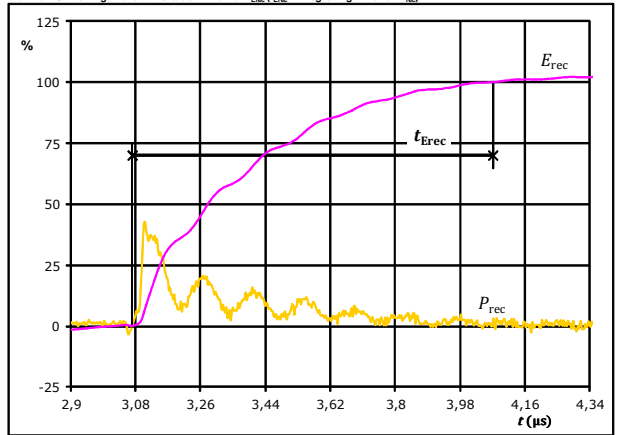
Brake Switching Definitions

Figure 8. FWD
 Turn-on Switching Waveforms & definition of t_{Qrr} (t_{Qrr} = integrating time for Q_{rr})



$I_d(100\%) =$	50	A
$Q_{rr}(100\%) =$	5,46	μC
$t_{Qrr} =$	1,00	μs

Figure 9. FWD
 Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})



$P_{rec}(100\%) =$	29,99	kW
$E_{rec}(100\%) =$	2,45	mJ
$t_{Erec} =$	1,00	μs



Ordering Code & Marking							
Version	Ordering Code	in DataMatrix as		in packaging barcode as			
without thermal paste with Solder pins	V23990-P760-A60-PM	P760A60		P760A60			
without thermal paste with Press-fit pins	V23990-P760-A60Y-PM	P760A60Y		P760A60Y			
with thermal paste with Solder pins	V23990-P760-A60-/3/-PM	P760A60		P760A60-/3/			
with thermal paste with Press-fit pins	V23990-P760-A60Y-/3/-PM	P760A60Y		P760A60Y-/3/			

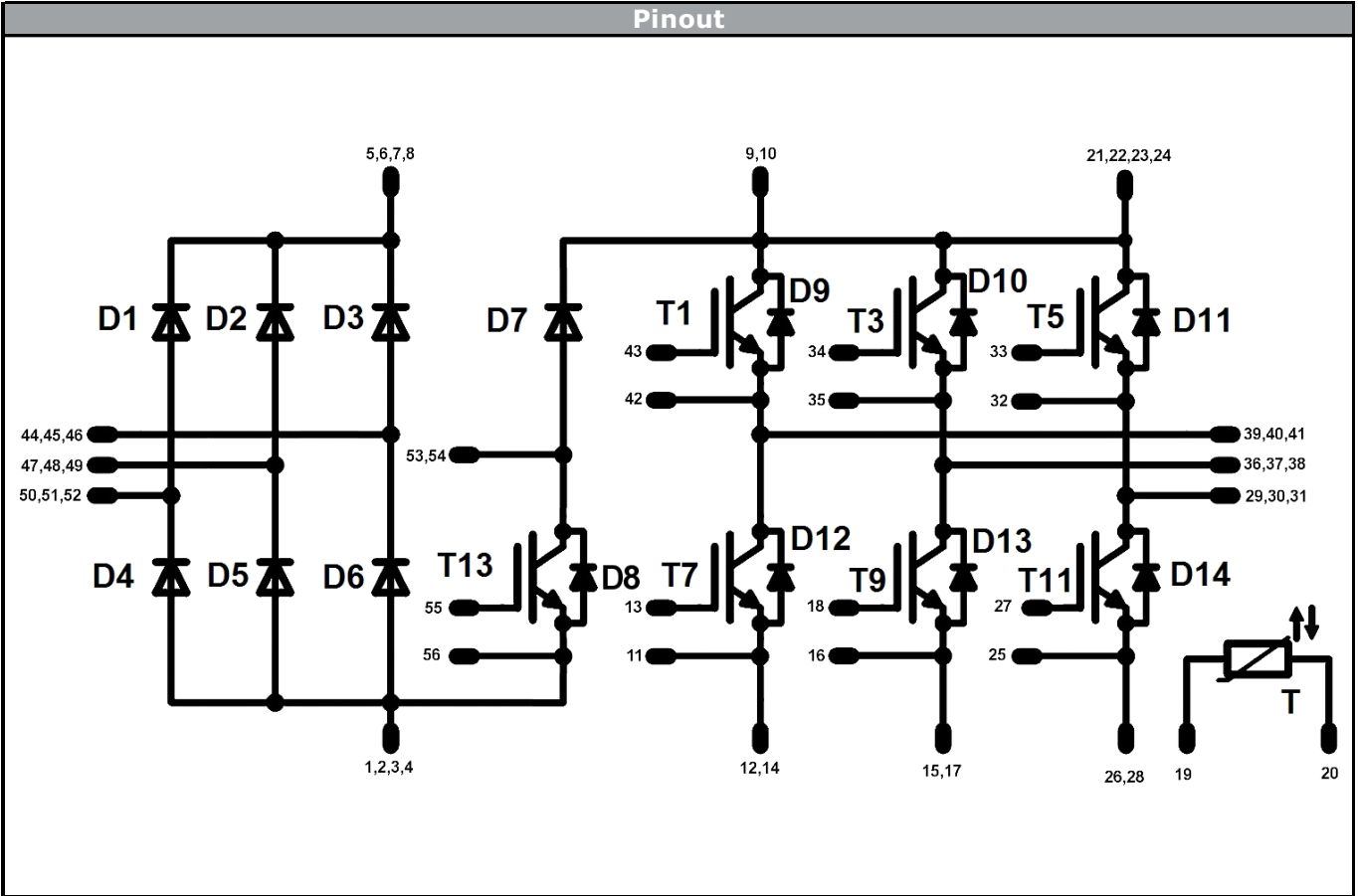
Vinco WWWW NNNNNNVV UL LLLL SSSS		Text	Vinco	Date code	Name&Ver	UL	Lot	Serial
			Vinco	WWYY	NNNNNNVV	UL	LLLL	SSSS
Datamatrix			Type&Ver	Lot number	Serial	Date code		
			TTTTTIVV	LLLL	SSSS	WWYY		

Outline							
Pin table [mm]				Pin table [mm]			
Pin	X	Y	Function	Pin	X	Y	Function
1	71,2	0	DC-	29	0	37,2	U
2	68,7	0	DC-	30	2,5	37,2	U
3	66,2	0	DC-	31	5	37,2	U
4	63,7	0	DC-	32	7,8	37,2	E
5	55,95	0	DC+	33	10,6	37,2	G
6	53,45	0	DC+	34	18,45	37,2	G
7	55,95	2,8	DC+	35	21,25	37,2	E
8	53,45	0	DC+	36	24,05	37,2	V
9	48,4	0	DC+	37	26,55	37,2	V
10	45,9	0	DC+	38	29,05	37,2	V
11	38,9	0	E	39	36,1	37,2	W
12	36,1	0	DC-	40	38,6	37,2	W
13	38,9	2,8	G	41	41,1	37,2	W
14	36,1	2,8	DC-	42	43,9	37,2	E
15	31,3	0	DC-	43	46,7	37,2	G
16	28,5	0	E	44	53,7	37,2	L1
17	31,3	2,8	DC-	45	56,2	37,2	L1
18	28,5	2,8	G	46	58,7	37,2	L1
19	19,3	0	R2	47	71,2	37,2	L2
20	19,3	2,8	R1	48	71,2	34,7	L2
21	12,3	0	DC+	49	71,2	32,2	L2
22	9,8	0	DC+	50	71,2	25,2	L3
23	12,3	2,8	DC+	51	71,2	22,7	L3
24	9,8	2,8	DC+	52	71,2	20,2	L3
25	2,8	0	E	53	68,7	12,8	BrC
26	0	0	DC-	54	71,2	12,8	BrC
27	2,8	2,8	G	55	71,2	5,6	BrG
28	0	2,8	DC-	56	71,2	2,8	BrG

Tolerance of pinpositions: ±0,5 mm at the end of pins
 Dimension of coordinate axis is only offset without tolerance



Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T1,T3,T5,T7,T9,T11	IGBT	1200V	100A	Inverter Switch	
D9-D14	FWD	1200V	100A	Inverter Diode	
T13	IGBT	1200V	50A	Brake Switch	
D7	FWD	1200V	25A	Brake Diode	
D8	FWD	1200V	10A	Brake Inverse Diode	
D1-D6	Rectifier	1600V	60A	Rectifier Diode	
C1,C2,C3,C4	Capacitor	1000V	-	DC Link	
T	NTC	-	-	Thermistor	



Packaging instruction			
Standard packaging quantity (SPQ)	42	>SPQ	Standard
		<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> 2 packages see vincotech.com website.

Package data
Package data for <i>flow</i> 2 packages see vincotech.com website.

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As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.